#### SILICON (Si) POWER MOSFET ▲ CED2015



CET MOS

# **CED2015**

# 150V 🛦 15.5mΩ 🛦 50A 🛦 Si MOSFET

SILICON Si MOSFET ▲ THT type N-channel enhancement mode UL94V-0 rated flame retardant epoxy TO251 (E-PAK) package Super high dense cell density for extremely low R<sub>DS(ON)</sub> High power and current handling capability

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FREE

RoHS



Parameter ( $T_c = 25^{\circ}C$ , unless otherwise noted)		Characteristics
Drain-Source Voltage	V <sub>DS</sub>	150V
Gate-Source Voltage	V <sub>GS</sub>	±20V
Continuous Drain Current at T <sub>c</sub> = 25°C	I <sub>D</sub>	50A
Pulsed Drain Current Note 1	I <sub>DM</sub>	200A
Maximum Power Dissipation at T <sub>c</sub> = 25°C	PD	96.2W
Power Dissipation Derating above 25°C	ΔP <sub>D</sub>	0.77W/°C
Single Pulsed Avalanche Energy Note 4	E <sub>AS</sub>	183mJ
Single Pulsed Avalanche Current Note 4	I <sub>AS</sub>	35A
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55°C to +150°C

# THERMAL CHARACTERISTICS

Parameter	Symbol	Limit
Thermal Resistance, Junction-to-Case	R <sub>TH_JC</sub>	1.3°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>TH_JA</sub>	50°C/W

#### **APPLICATIONS**

Battery Management Systems	E-Bike	Industrial Control	Power Inverter	UPS
+ 4 -	50			

#### **PIN DESCRIPTION**

Circuit Diagram	Outline - Front View	Pin No.	Description
G (1) S (3)		1 2 3	Gate Drain Source

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#### **ELECTRICAL CHARACTERISTICS** A T<sub>c</sub> = 25°C, unless otherwise noted

ltem	Condition	Symbol	Min.	Тур.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	$V_{GS} = 0V$ , $I_D = 250\mu A$	BV <sub>DSS</sub>	150			V
Zero Gate Voltage Drain Current	$V_{DS}$ = 150V, $V_{GS}$ = 0V	I <sub>DSS</sub>			1	μΑ
Gate Body Leakage Current, Forward	$V_{GS} = 20V, V_{DS} = 0V$	I <sub>GSSF</sub>			100	nA
Gate Body Leakage Current, Reverse	$V_{GS}$ = -20V, $V_{DS}$ = 0V	I <sub>GSSR</sub>			-100	nA
On Characteristics Note 2						
Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$	V <sub>GS(th)</sub>	2		4	V
Static Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 30A$	R <sub>DS(ON)</sub>		15.5	20	mΩ
Dynamic Characteristics Note 3						
Input Capacitance	$V_{DS}$ = 100V, $V_{GS}$ = 0V, f = 1MHz	CISS		1870		рF
Output Capacitance	$V_{DS} = 100V, V_{GS} = 0V, f = 1MHz$	Coss		180		рF
Reverse Transfer Capacitance	$V_{DS}$ = 100V, $V_{GS}$ = 0V, f = 1MHz	C <sub>RSS</sub>		2		рF
Switching Characteristics Note 3						
Turn-On Delay Time	$V_{\text{DD}}$ = 120V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 20A, $R_{\text{G(ext)}}$ = $6\Omega$	t <sub>D(ON)</sub>		20		ns
Turn-On Rise Time	$V_{\text{DD}}$ = 120V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 20A, $R_{\text{G(ext)}}$ = $6\Omega$	t <sub>R</sub>		7		ns
Turn-Off Delay Time	$V_{\text{DD}}$ = 120V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 20A, $R_{\text{G(ext)}}$ = 6 $\Omega$	t <sub>D(OFF)</sub>		40		ns
Turn-Off Fall Time	$V_{\text{DD}}$ = 120V, $V_{\text{GS}}$ = 10V, $I_{\text{D}}$ = 20A, $R_{\text{G(ext)}}$ = 6 $\Omega$	t <sub>F</sub>		21		ns
Total Gate Charge	$V_{DS}$ = 120V, $V_{GS}$ = 10V, $I_D$ = 20A	Q <sub>G</sub>		28		nC
Gate Source Charge	$V_{DS}$ = 120V, $V_{GS}$ = 10V, $I_{D}$ = 20A	Q <sub>GS</sub>		8		nC
Gate Drain Charge	$V_{DS}$ = 120V, $V_{GS}$ = 10V, $I_D$ = 20A	$\mathbf{Q}_{GD}$		6		nC
Drain-Source Diode Characteristics a	nd Maximum Ratings					
Drain-Source Diode Forward Current		I <sub>S</sub>			47	А
Drain-Source Diode Forward Voltage <sup>Note 2</sup>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	$V_{\text{SD}}$			1.2	V

#### Notes

- 2: Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 3: Guaranteed by design, not subject to production testing.
- 4:  $L = 0.3 \text{mH}, I_{AS} = 35 \text{A}, V_{DD} = 24 \text{V}, R_G = 25 \Omega$ , Starting T<sub>J</sub> = 25°C

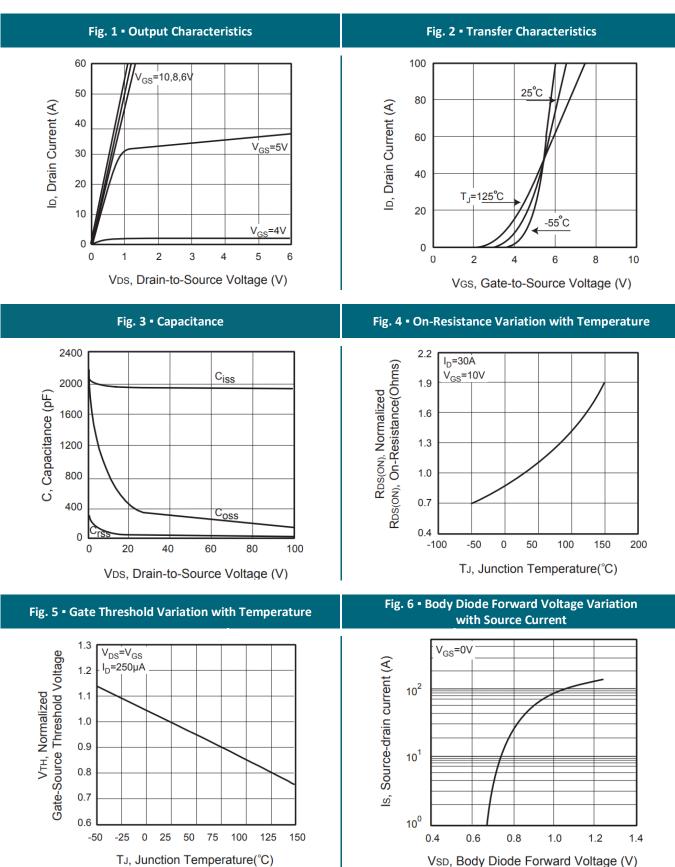
<sup>1:</sup> Repetitive Rating: Pulse width limited by maximum junction temperature



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# **REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE**



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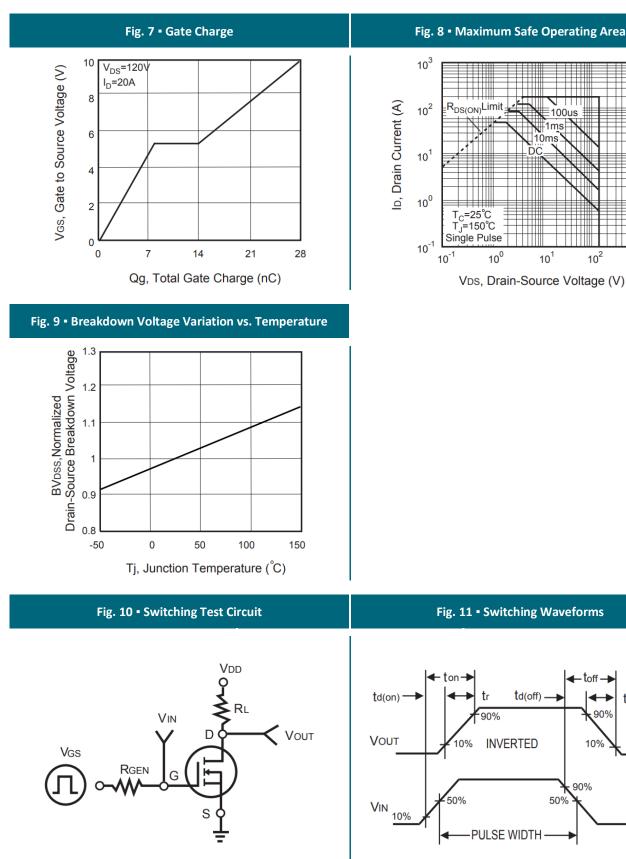


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 $10^{3}$ 

tf

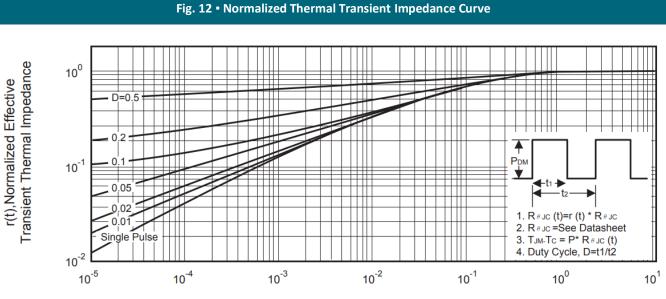
#### **REFERENCE DATA A TYPICAL DEVICE PERFORMANCE**





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# **REFERENCE DATA ▲ TYPICAL DEVICE PERFORMANCE**

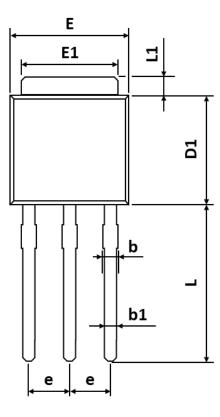


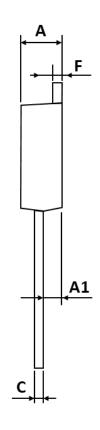
Square Wave Pulse Duration (sec)

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### **PACKAGE OUTLINE**





Sym	Millimeters (Min.)	Millimeters (Typ.)	Millimeters (Max.)
А	2.180	-	2.400
A1	0.860	-	1.500
b	0.700	-	0.960
b1	0.700	-	0.860
С	0.400	-	0.610
D1	5.400	-	6.630
E	6.050	-	7.010
E1	4.950	-	5.460
е	1.980	-	2.590
F	0.400	-	0.890
L	8.500	-	9.650
L1	0.500	-	1.800

#### **ORDERING INFORMATION**

Part Number	Package	Packing	Tube Qty.	Inner Box Qty.	Outer Box Qty.
CED2015	TO251 (E-PAK)	Tube	80pcs	4,000pcs	16,000pcs

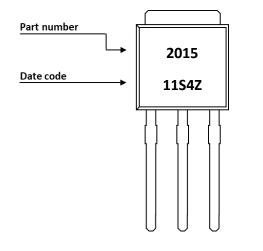
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#### **PART MARKING**



# DATE CODE

Example: 11S4Z



| Product Type Z: Pb-free G: Green Product

	Coding list for "Day"								
<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>	<b>7</b>	<b>8</b>	<b>9</b>	<b>A</b>
01	02	03	04	05	06	07	08	09	10
<b>B</b>	<b>C</b>	<b>D</b>	<b>E</b>	<b>F</b>	<b>G</b>	<b>H</b>	<b> </b>	<b>J</b>	<b>K</b>
11	12	13	14	15	16	17	18	19	20
<b>L</b>	<b>M</b>	<b>N</b>	<b>0</b>	<b>P</b>	<b>Q</b>	<b>R</b>	<b>S</b>	<b>T</b>	<b>U</b>
21	22	23	24	25	26	27	28	29	30
<b>V</b> 31									

Coding list for "Month"

<b>1</b> Jan	<b>2</b> Feb		<b>5</b> May	
<b>7</b> Jul	<b>8</b> Aug		<b>B</b> Nov	<b>C</b> Dec

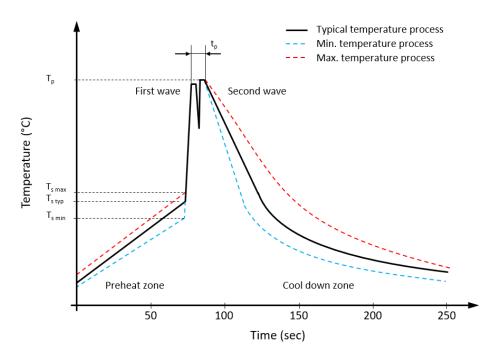
Coding list for "Year"







# **RECOMMENDED WAVE SOLDERING PROFILE ▲ THT PACKAGE**



#### Classification wave soldering profile ▲ Refer to EN 61760-1: 2006

Profile Features		Value 🛦 Sn-Pb Assembly	Value 🔺 Pb-free Assembly
Preheat temperature min.	$T_{s min}$	100 °C	100 °C
Preheat temperature typical	T <sub>s typ</sub>	120 °C	120 °C
Preheat temperature max.	$T_{s max}$	130 °C	130 °C
Preheat time $t_s$ from $T_{s min}$ to $T_{s max}$	ts	70 seconds	70 seconds
Peak temperature	Tp	235 °C to 260 °C	245 °C to 260 °C
Time of actual peak temperature	t <sub>p</sub>	Max. 10 seconds Max. 5 second each wave	Max. 10 seconds Max. 5 second each wave
Ramp-down date min.		~ 2 °C/second	~ 2 °C/second
Ramp-down rate typical		~ 3.5 °C/second	~ 3.5 °C/second
Ramp-down rate max.		~ 5 °C/second	~ 5 °C/second
Time 25°C to 25°C		4 minutes	4 minutes

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#### **REVISION TABLE**

Revision	Date	Status	Notes
001	30/09/2022	Initial release	Initial publication

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